

TOSHIBA Transistor Silicon PNP Epitaxial Type

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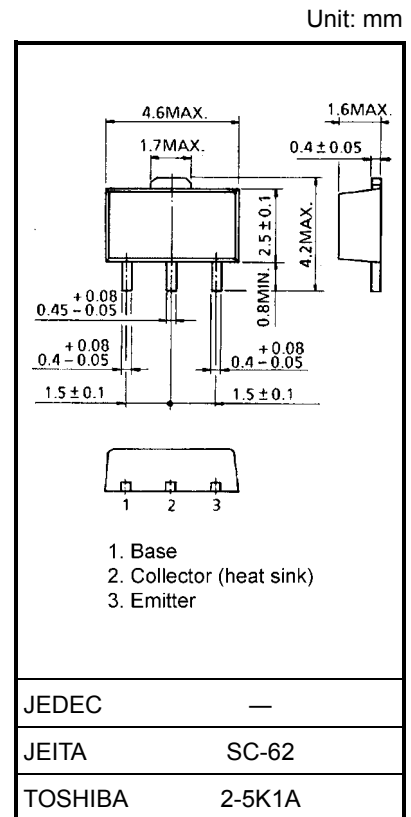
High-Speed Switching Applications
DC-DC Converter Applications

- High DC current gain: $h_{FE} = 200$ to 500 ($I_C = -0.15$ A)
- Low collector-emitter saturation voltage: $V_{CE(sat)} = -0.14$ V (max)
- High-speed switching: $t_f = 37$ ns (typ.)

Maximum Ratings ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Rating	Unit
Collector-base voltage		V_{CBO}	-20	V
Collector-emitter voltage		V_{CEO}	-20	V
Emitter-base voltage		V_{EBO}	-7	V
Collector current	DC	I_C	-1.5	A
	Pulse	I_{CP}	-2.5	
Base current		I_B	-150	mA
Collector power dissipation	$t = 10$ s	P_C	2.0	W
	DC	(Note 1)	1.0	
Junction temperature		T_j	150	$^\circ\text{C}$
Storage temperature range		T_{stg}	-55 to 150	$^\circ\text{C}$

Note 1: Mounted on FR4 board (glass epoxy, 1.6 mm thick, Cu area: 645 mm^2)



Weight: 0.05 g (typ.)

Electrical Characteristics ($T_a = 25^\circ\text{C}$)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Collector cut-off current		I_{CBO}	$V_{CB} = -20$ V, $I_E = 0$	—	—	-100	nA
Emitter cut-off current		I_{EBO}	$V_{EB} = -7$ V, $I_C = 0$	—	—	-100	nA
Collector-emitter breakdown voltage		$V_{(BR)CEO}$	$I_C = -10$ mA, $I_B = 0$	-20	—	—	V
DC current gain		$h_{FE(1)}$	$V_{CE} = -2$ V, $I_C = -0.15$ A	200	—	500	
		$h_{FE(2)}$	$V_{CE} = -2$ V, $I_C = -0.5$ A	125	—	—	
Collector-emitter saturation voltage		$V_{CE(sat)}$	$I_C = -0.5$ A, $I_B = -17$ mA	—	—	-0.14	V
Base-emitter saturation voltage		$V_{BE(sat)}$	$I_C = -0.5$ A, $I_B = -17$ mA	—	—	-1.10	V
Collector output capacitance		C_{ob}	$V_{CB} = -10$ V, $I_E = 0$, $f = 1$ MHz	—	12	—	pF
Switching time	Rise time	t_r	See Figure 1 circuit diagram.	—	40	—	ns
	Storage time	t_{stg}	$V_{CC} \approx -10$ V, $R_L = 20$ Ω	—	135	—	
	Fall time	t_f	$-I_{B1} = I_{B2} = -17$ mA	—	37	—	

Marking

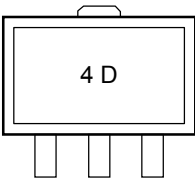
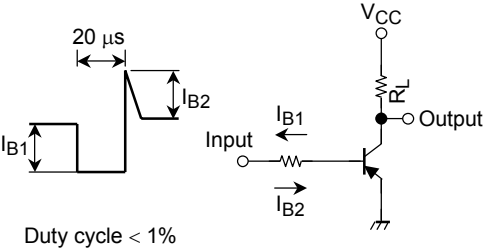
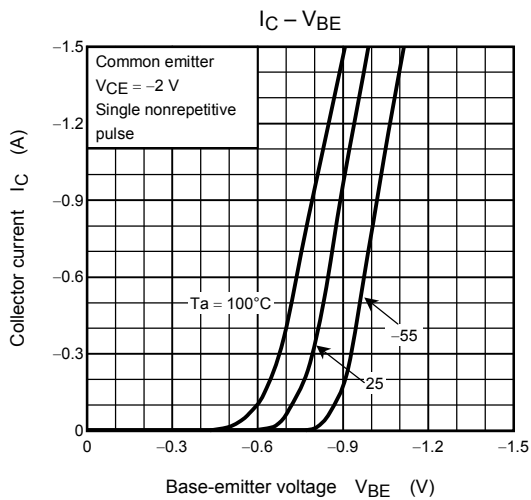
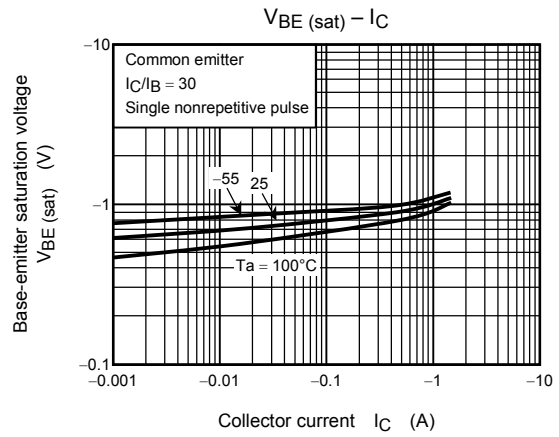
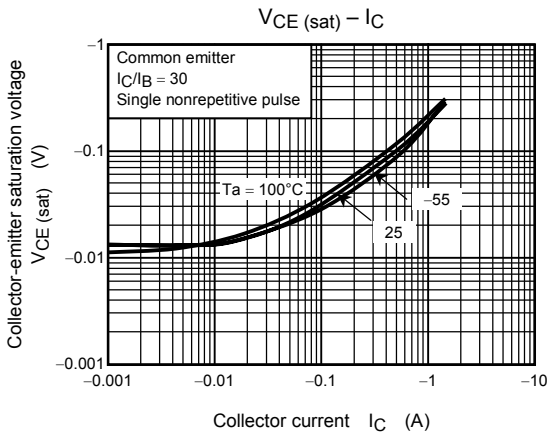
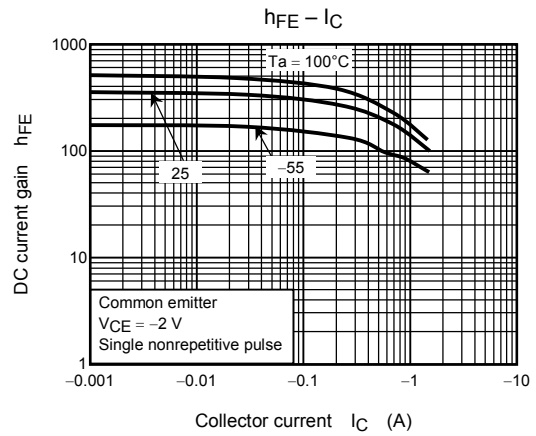
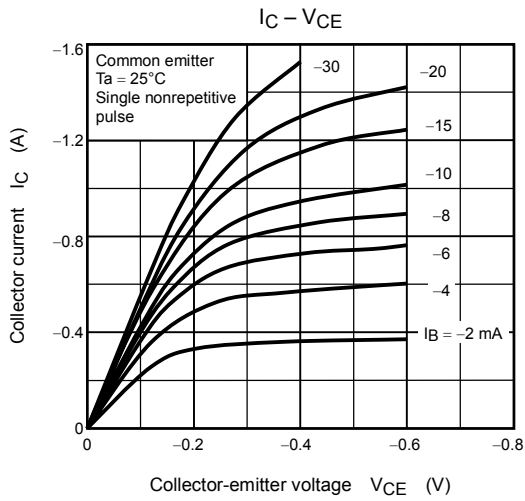
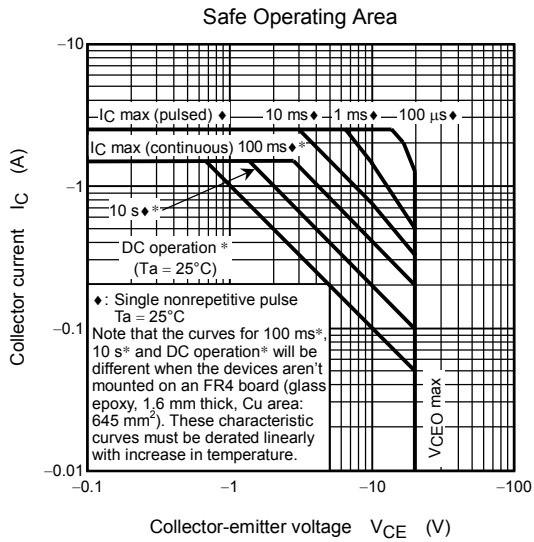
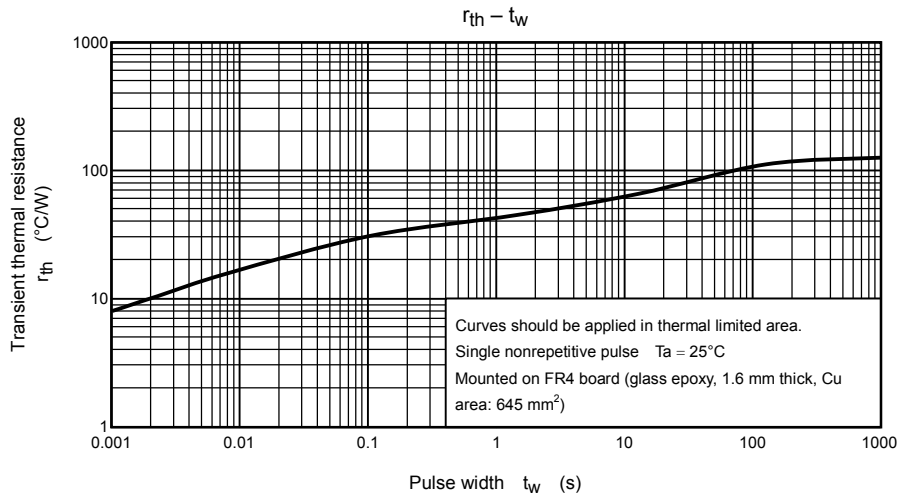


Figure 1 Switching Time Test Circuit & Timing Chart





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